

# Integrated Switch and LNA Module

## 2 - 5 GHz



MAMF-011170

Rev. V1

### Features

- High Power SPDT Switch and 2-Stage LNA
- Broadband: 2 - 5 GHz
- No External Matching Components Required for n78 5G NR Band
- RX Mode Gain:
  - 38.5 dB @ 2.5 GHz
  - 37.0 dB @ 3.75 GHz
- RX Mode Noise Figure:
  - 0.9 dB @ 2.5 GHz
  - 1.0 dB @ 3.75 GHz
- TX Mode @ 2 - 5 GHz:
  - Insertion Loss: 0.35 dB
  - P0.1dB: 41 dBm
- Single 5 V Supply
- Low DC Current: 80 mA in RX Mode
- Integrated Control Circuitry with 1.8 V Logic
- Lead-Free 3 mm 16 Lead QFN Package
- RoHS\* Compliant

### Applications

- 5G Massive MIMO
- Wireless Infrastructure
- TDD-based communication systems

### Description

The MAMF-011170 is a compact surface mount, highly integrated high power SPDT switch and 2-stage low noise amplifier (LNA) module. It includes an antenna switch and a LNA in a compact 3 mm QFN package. All the bias circuitry and matching components for n78 5G NR band are internal to the module.

This module operates from 2 - 5 GHz and features high power handling, low noise figure, high linearity and low power consumption. The module requires a single 5 V supply and the T/R switch is 1.8 V CMOS compatible.

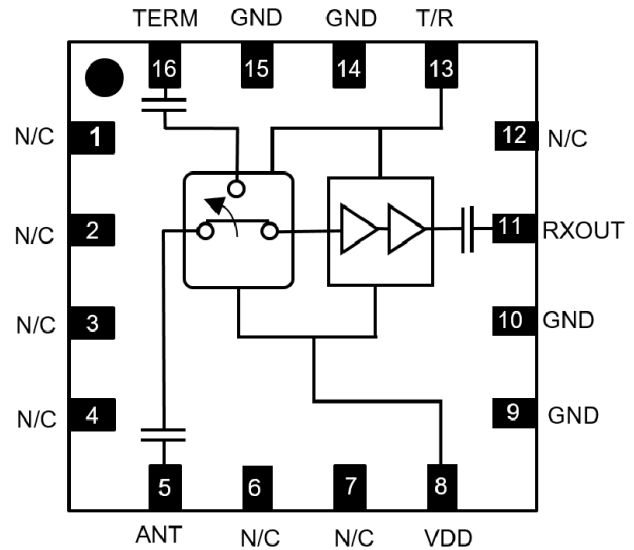
### Ordering Information<sup>1</sup>

Part Number	Package
MAMF-011170-TR1000	1K reel
MAMF-011170-001SMB	Sample Board

1. Reference Application Note M513 for reel size information.

\* Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

### Functional Block



### Pin Configuration<sup>2</sup>

Pin #	Pin Name	Description
1,2,3,4,6,7,12	N/C	Internally No Connect
5	ANT	Antenna Port
8	V <sub>DD</sub>	Supply Voltage
9,10,14,15	GND	Ground
11	RXOUT	RX Output Port
13	T/R	Logic Signaling Pin
16	TERM	Termination Port
17	Paddle <sup>4</sup>	Ground

2. MACOM recommends connecting N/C pins to ground.

3. The exposed pad centered on the package bottom must be connected to PCB ground with low electrical and thermal resistances.

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### AC Electrical Specifications (RX Mode):

$P_{IN} = -30 \text{ dBm}$ ,  $T_C = +25^\circ\text{C}$ ,  $V_{DD} = 5 \text{ V}$ ,  $Z_0 = 50 \Omega$

Parameter	Test Conditions	Units	Min.	Typ.	Max.
Gain	ANT to RXOUT, 2.5 GHz ANT to RXOUT, 3.75 GHz	dB	35 34.5	38.5 37.0	—
Input IP3	$P_{IN}/\text{tone} = -30 \text{ dBm}$ , Tone Delta = 2 MHz, ANT to RXOUT, 2.5 GHz ANT to RXOUT, 3.75 GHz	dBm	—	-6.5 -2.9	—
Input P1dB	ANT to RXOUT, 2.5 GHz ANT to RXOUT, 3.75 GHz	dBm	—	-19.3 -17.7	—
Noise Figure	ANT to RXOUT, 2.5 GHz ANT to RXOUT, 3.75 GHz	dB	—	0.9 1.0	—
ANT Port Return Loss	ANT Port, 2.5 GHz ANT Port, 3.75 GHz	dB	—	6 19	—
RXOUT Port Return Loss	RXOUT Port, 2.5 GHz RXOUT Port, 3.75 GHz	dB	—	21 12	—
Reverse Isolation	RXOUT to ANT, 2.5 GHz RXOUT to ANT, 3.75 GHz	dB	—	48 46	—

### AC Electrical Specifications (TX Mode):

$P_{IN} = -30 \text{ dBm}$ ,  $T_C = +25^\circ\text{C}$ ,  $V_{DD} = 5 \text{ V}$ ,  $Z_0 = 50 \Omega$

Parameter	Test Conditions	Units	Min.	Typ.	Max.
Insertion Loss	ANT to TERM, 2.5 GHz ANT to TERM, 3.75 GHz	dB	—	0.30 0.35	0.8
P0.1dB Compression Point	2 $\mu\text{s}$ pulse width, 10% duty cycle, ANT to TERM, 2.5 GHz, ANT to TERM, 3.75 GHz	dBm	—	41 41	—
ANT Port Return Loss	ANT Port, 2.5 GHz ANT Port, 3.75 GHz	dB	—	25 22	—
TERM Port Return Loss	TERM Port, 2.5 GHz TERM Port, 3.75 GHz	dB	—	26 22	—
ANT - RXOUT Isolation	ANT to RXOUT, 2.5 GHz ANT to RXOUT, 3.75 GHz	dB	—	56 53	—
ANT Port Input Power	ANT Port, 2.5 GHz, CW, $T_C = 105^\circ\text{C}$ ANT Port, 2.5 GHz, LTE (10dB PAR), $T_C = 105^\circ\text{C}$	dBm	—	39 36	—

**Transient Electrical Specifications:**

**Freq. = 2.5 GHz, P<sub>IN</sub> = -30 dBm, T<sub>C</sub> = 25°C, V<sub>DD</sub> = 5 V, Z<sub>0</sub> = 50 Ω**

Parameter	Test Conditions	Units	Min.	Typ.	Max.
T/R Gain Settling Time	ANT to RXOUT gain settling time within 0.3 dB of final value after T/R command	μs	—	0.3	—
T/R Insertion Loss Settling Time	ANT to TERM path insertion loss settling time within 0.3 dB of final value after T/R command	μs	—	0.3	—
Power on Gain Settling Time	ANT to RXOUT gain settling time within 0.5 dB of final value after DC power on	ms	—	1	—
Power on Insertion Loss Settling Time	ANT to TERM settling time within 0.5 dB of final value after DC power on	ms	—	1	—

**DC Electrical Specifications: T<sub>C</sub> = 25°C, V<sub>DD</sub> = 5 V, Z<sub>0</sub> = 50 Ω**

Parameter	Test Conditions	Units	Min.	Typ.	Max.
Supply Voltage	—	V	4.75	5	5.25
Amplifier Bias Current	RX Mode TX Mode	mA	—	80 2.3	—
T/R Control Voltage	RX Mode, Logic High TX Mode, Logic Low	V	—	1.8 0	—
T/R Logic Input Current	RX Mode, Logic High TX Mode, Logic Low	μA	—	40 0.04	—

**Control Truth Table**

T/R Control	
RX Mode	Logic High
TX Mode	Logic Low or Open

### Absolute Maximum Ratings<sup>4,5</sup>

Parameter	Absolute Maximum
Antenna Input Power <sup>6</sup> Freq. = 2.5 GHz: RX Mode TX Mode	23 dBm LTE (10 dB PAR), 26 dBm CW 39 dBm LTE (10 dB PAR), 41 dBm CW
DC Voltages: $V_{DD}$ , ANT & TERM T/R & RXOUT	-0.5 to +5.5 V -0.5 to +2.75 V
Junction Temperature: RX Mode <sup>7,9</sup> TX Mode <sup>7,9</sup> TX Mode <sup>6</sup>	+150°C +125°C +140°C
Operating Temperature <sup>8</sup>	-40°C to +105°C
Storage Temperature	-55°C to +150°C

4. Exceeding any one or combination of these limits may cause permanent damage to this device.
5. MACOM does not recommend sustained operation near these survivability limits.
6. Single event, up to 10 seconds duration.
7. Operating at nominal conditions with  $T_J \leq +150^\circ\text{C}$  (RX Mode) and  $T_J \leq +125^\circ\text{C}$  (TX Mode) will ensure MTTF  $\gg 1 \times 10^6$  hours.
8. Operating/Case temperature ( $T_C$ ) is the temperature of the exposed paddle.
9. Junction Temperature ( $T_J$ ) =  $T_C + \Theta_{JC} * P_{DISS}$  where  $P_{DISS}$  is the total DC & RF dissipated power.
  - RX Mode: Typical thermal resistance ( $\Theta_{JC}$ ) = 33.4°C/W.
  - TX Mode: Typical thermal resistance ( $\Theta_{JC}$ ) = 15.3°C/W.

### Handling Procedures

Please observe the following precautions to avoid damage:

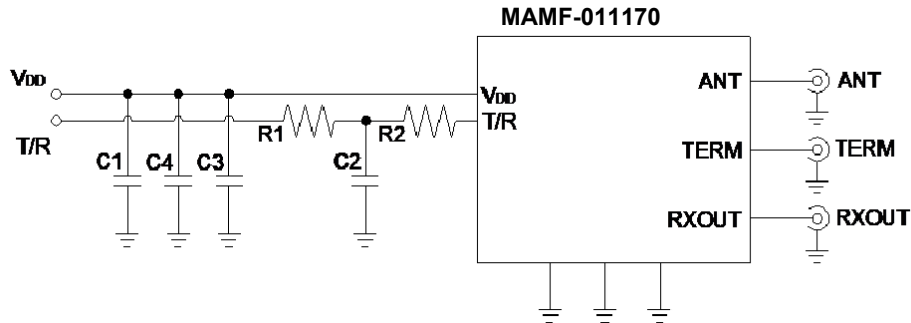
### Static Sensitivity

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM Class 2 and CDM Class C3 devices.

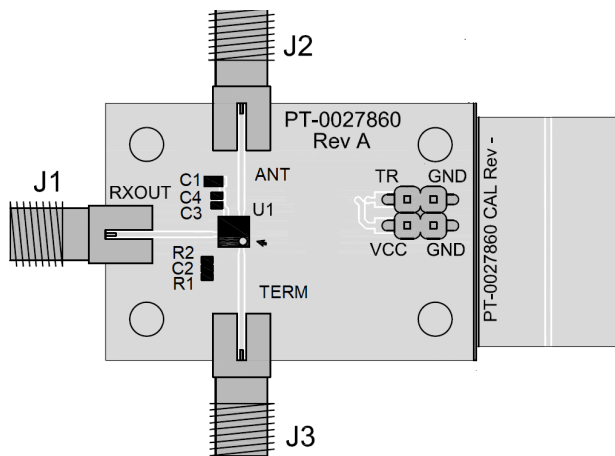
### Power Supplies

De-coupling capacitors should be placed at the  $V_{DD}$  supply pin to minimize noise and fast transients. Supply voltage change or transients should have a slew rate smaller than 1 V / 10  $\mu\text{s}$ . In addition, all control pins should remain at 0 V (+/- 0.3 V) and no RF power should be applied while the supply voltage ramps or while it returns to zero.

## Sample Board Schematic



## Sample Board PCB Layout

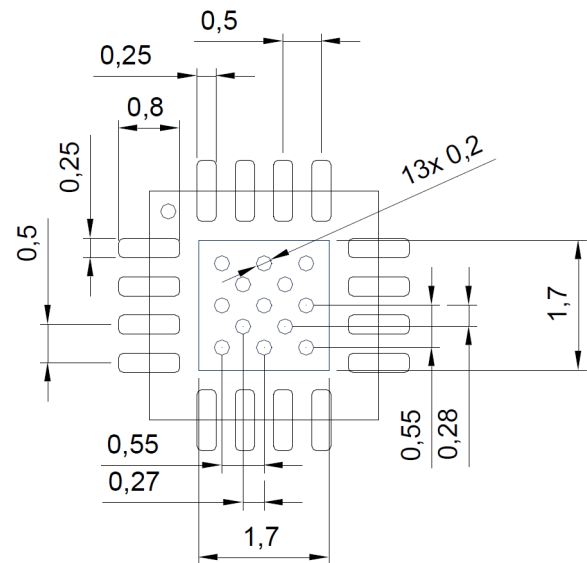


- Material: Rogers 4003C
- Dielectric thickness: 0.203 mm
- Track/Gap: 0.394/0.25 mm
- Finished copper thickness: 44  $\mu\text{m}$  +/- 10  $\mu\text{m}$
- Finish both sides: 0.075  $\mu\text{m}$  gold over 4.5  $\mu\text{m}$  nickel
- Further layout information available on request

## Parts List

Part	Value	Case style
C1	10 $\mu\text{F}$	0603
C2	5 pF	0402
C3	470 pF	0402
C4	10 nF	0402
R1	1 k $\Omega$	0402
R2	100 $\Omega$	0402

## Recommended Thermal Land Pattern

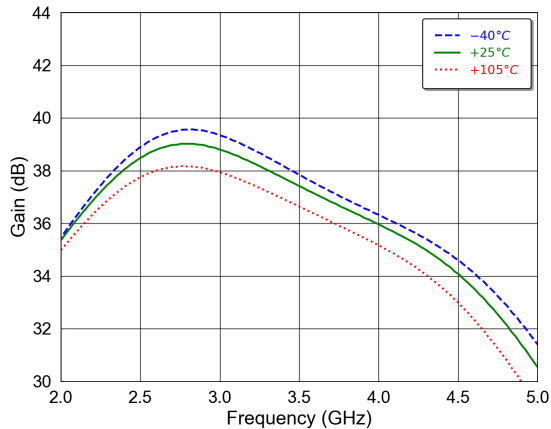


- 13 Ground Vias
- 0.2 mm Diameter, 1/2 oz. Copper

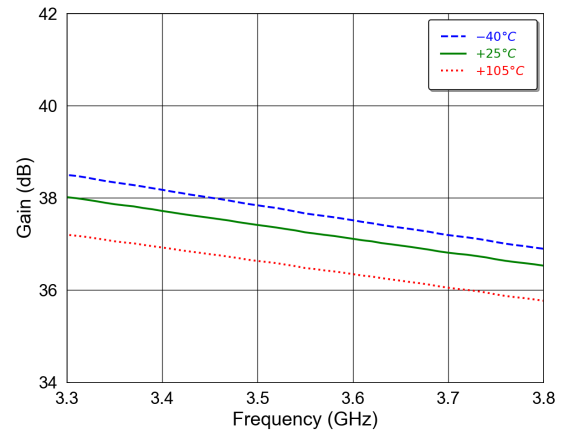
### Typical Performance Curves:

$P_{IN} = -30 \text{ dBm}$ ,  $V_{DD} = 5 \text{ V}$ ,  $T_C = +25^\circ\text{C}$ ,  $Z_0 = 50 \Omega$  (unless otherwise indicated)

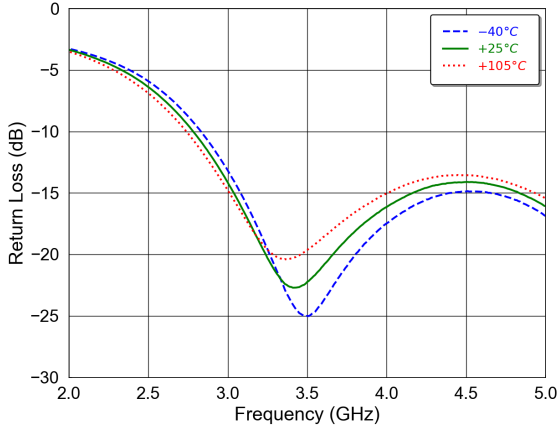
**ANT to RXOUT Gain<sup>10</sup> - RX Mode**



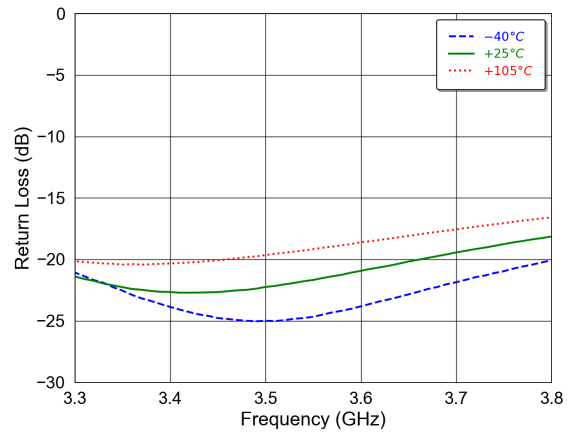
**ANT to RXOUT Gain<sup>10</sup> - RX Mode**



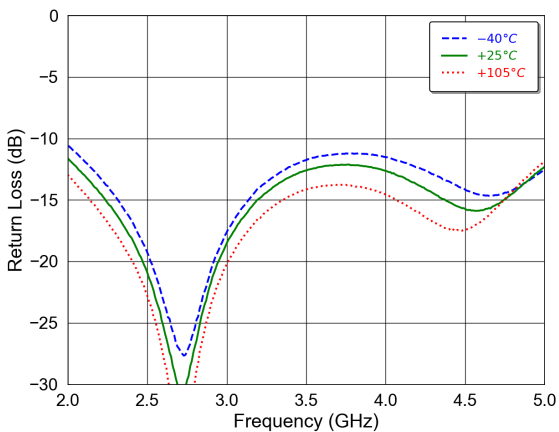
**ANT Port Return Loss - RX Mode**



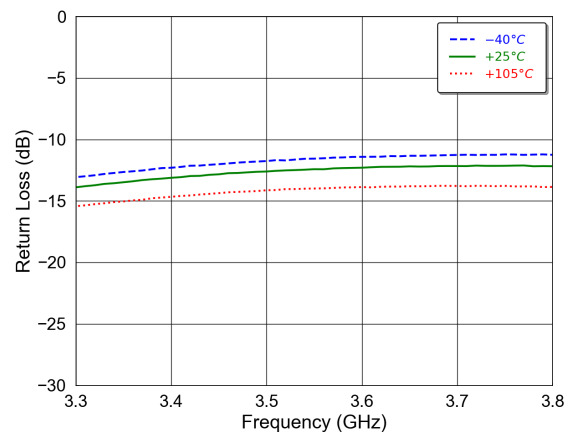
**ANT Port Return Loss - RX Mode**



**RXOUT Port Return Loss - RX Mode**



**RXOUT Port Return Loss - RX Mode**

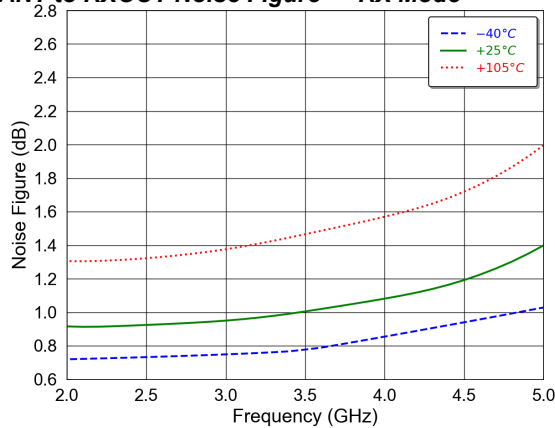


10. For gain, noise figure, insertion loss, P1dB and isolation plots, RF trace and connector losses are de-embedded.

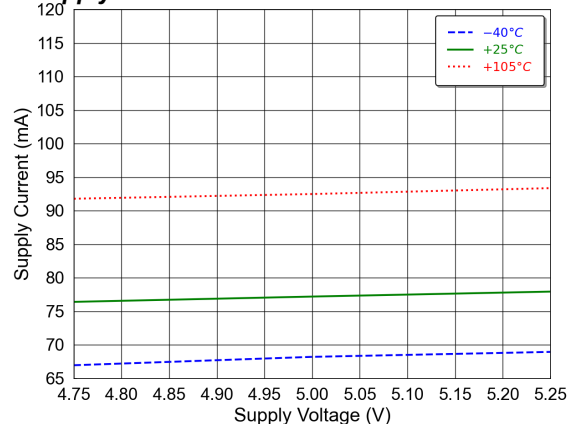
### Typical Performance Curves:

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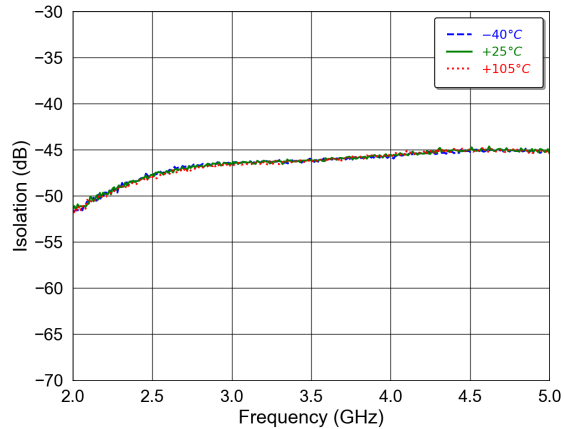
**ANT to RXOUT Noise Figure<sup>10</sup> - RX Mode**



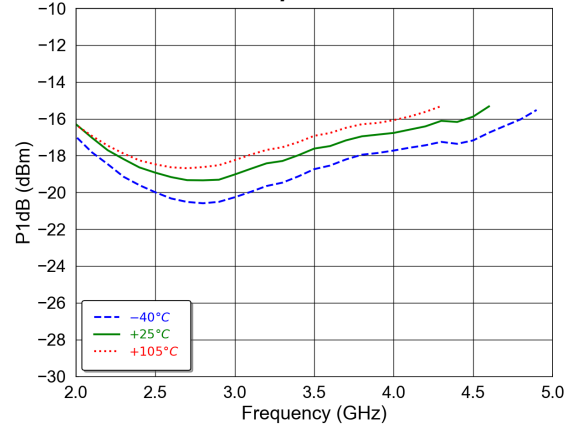
**Supply Current - RX Mode**



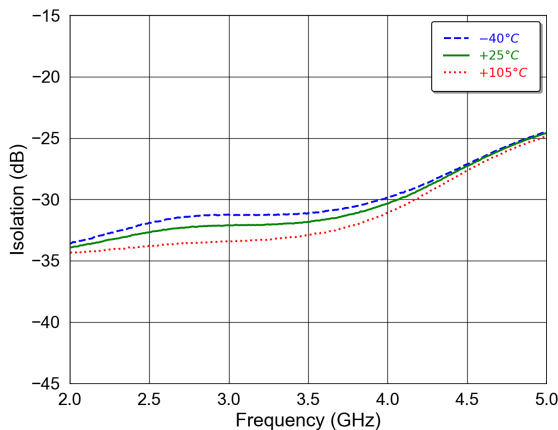
**ANT to RXOUT Port Reverse Isolation<sup>10</sup> - RX Mode**



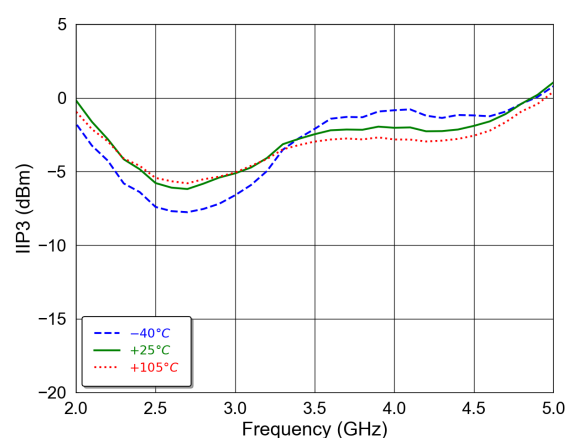
**ANT to RXOUT Port Input P1dB<sup>10</sup> - RX Mode**



**ANT to TERM Port Switch Isolation<sup>10</sup> - RX Mode**



**ANT to RXOUT Port Input IP3 - RX Mode**

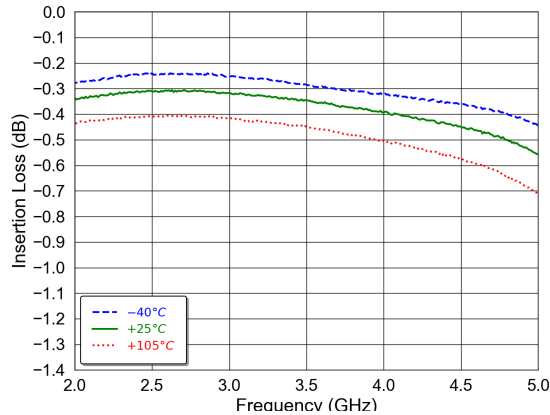


10. For gain, noise figure, insertion loss, P1dB and isolation plots, RF trace and connector losses are de-embedded.

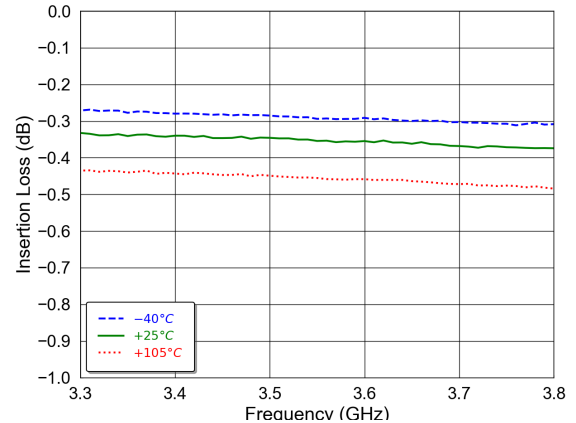
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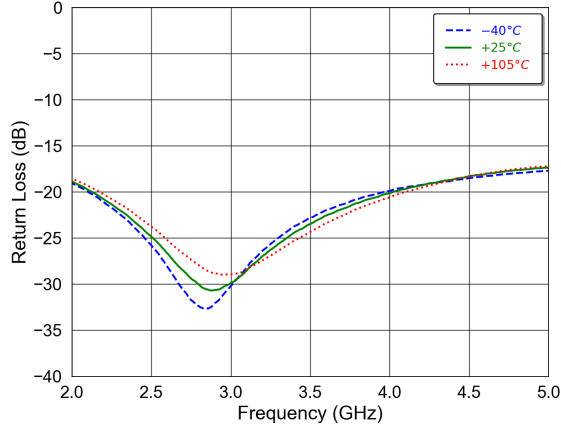
**ANT to TERM Switch Insertion Loss<sup>10</sup> - TX Mode**



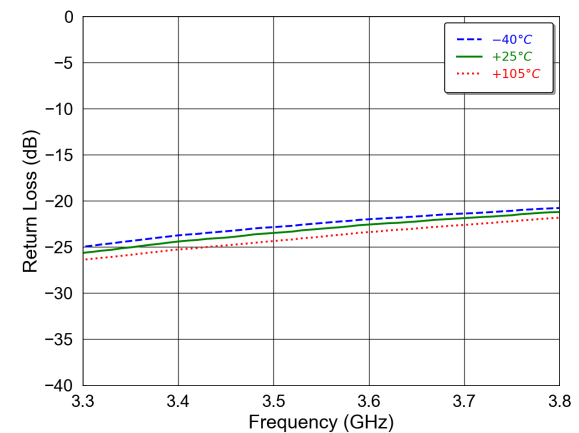
**ANT to TERM Switch Insertion Loss<sup>10</sup> - TX Mode**



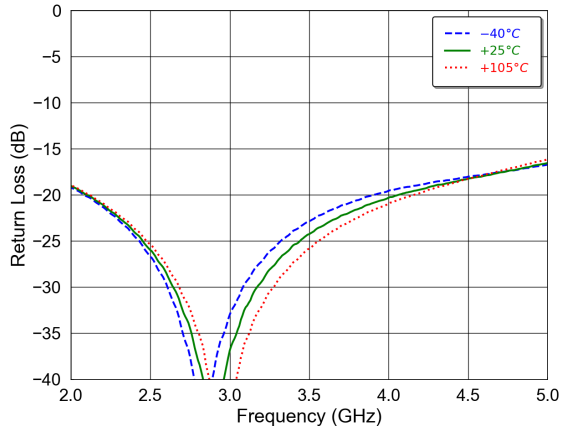
**ANT Port Return Loss - TX Mode**



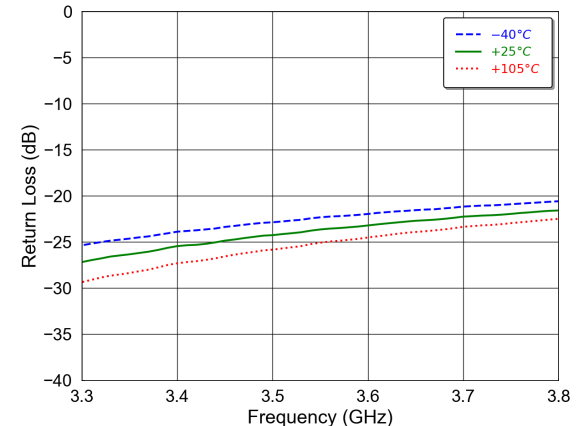
**ANT Port Return Loss - TX Mode**



**TERM Port Return Loss - TX Mode**



**TERM Port Return Loss - TX Mode**



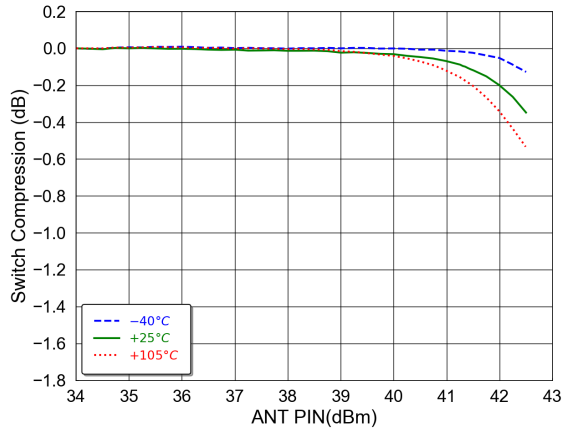
10. For gain, noise figure, insertion loss, P1dB and isolation plots, RF trace and connector losses are de-embedded.



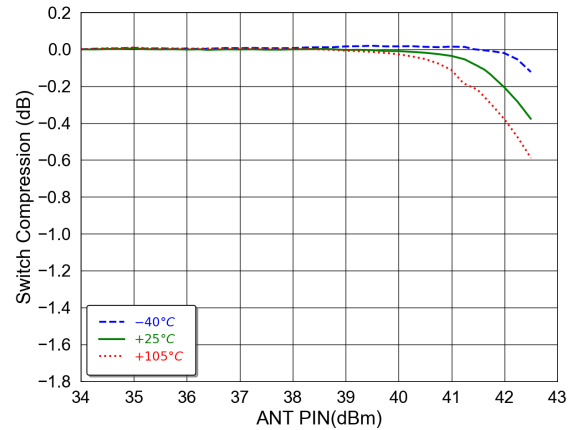
### Typical Performance Curves

$P_{IN} = -30$  dBm,  $V_{DD} = 5$  V,  $T_C = +25^\circ\text{C}$ ,  $Z_0 = 50 \Omega$  (unless otherwise indicated)

**ANT to TERM Port Switch Compression Characteristic<sup>11</sup> at 2.5 GHz - TX mode**

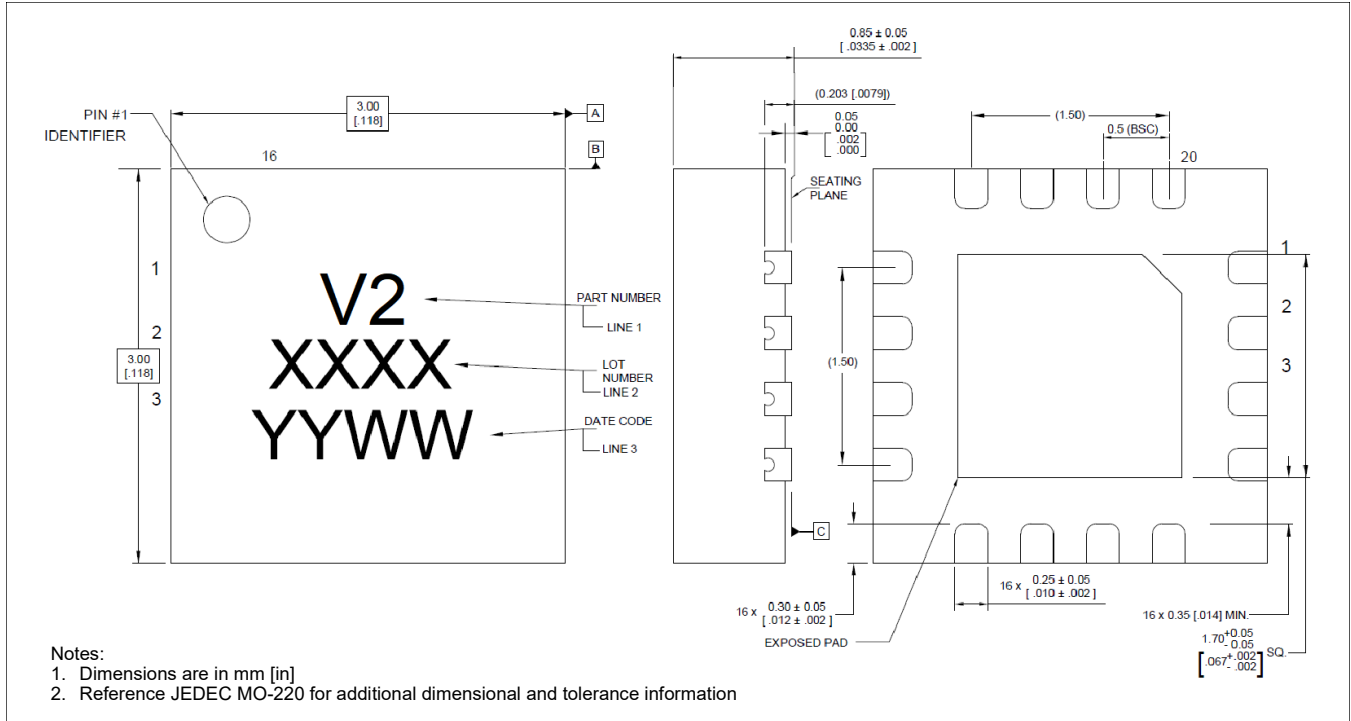


**ANT to TERM Port Switch Compression Characteristic<sup>11</sup> at 3.75 GHz - TX mode**



11. Measured with 2  $\mu\text{s}$  pulse width, 10% duty cycle. RF trace and connector losses are de-embedded.

**Lead-Free 3 mm 16-Lead QFN<sup>†</sup>**



<sup>†</sup> Reference Application Note S2083 for lead-free solder reflow recommendations.  
Meets JEDEC moisture sensitivity level 1 requirements in accordance to JEDEC J-STD-020D.  
Plating is NiPdAu over Copper

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